

SMAG

## S2A THRU S2M General Purpose Rectifier Diodes

## Features

- I<sub>F(AV)</sub>
- VRRM 50V-1000V
- High surge current capability

2A

• Polarity: Color band denotes cathode

### Applications

• Rectifier

### Marking

- S2X
  - X: From A To M

## Limiting Values(Absolute Maximum Rating)

	Symbol	Unit		S2							
Item			Test Conditions	Α	В	D	G	J	Κ	М	
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	V		50	100	200	400	600	800	1000	
Maximum RMS Voltage	V <sub>RMS</sub>	V		35	70	140	280	420	560	700	
Average Forward Current	I <sub>F(AV)</sub>	A	60Hz Half-sine wave , Resistance load , $T_L$ =100 C	2.0							
Surge(Non-repetitive)Forward Current	I <sub>FSM</sub>	A	60Hz Half-sine wave, 1 cycle,Ta=25℃	50							
Operation Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	°C		-55 ~ +150							

### Electrical Characteristics (T=25°C Unless otherwise specified)

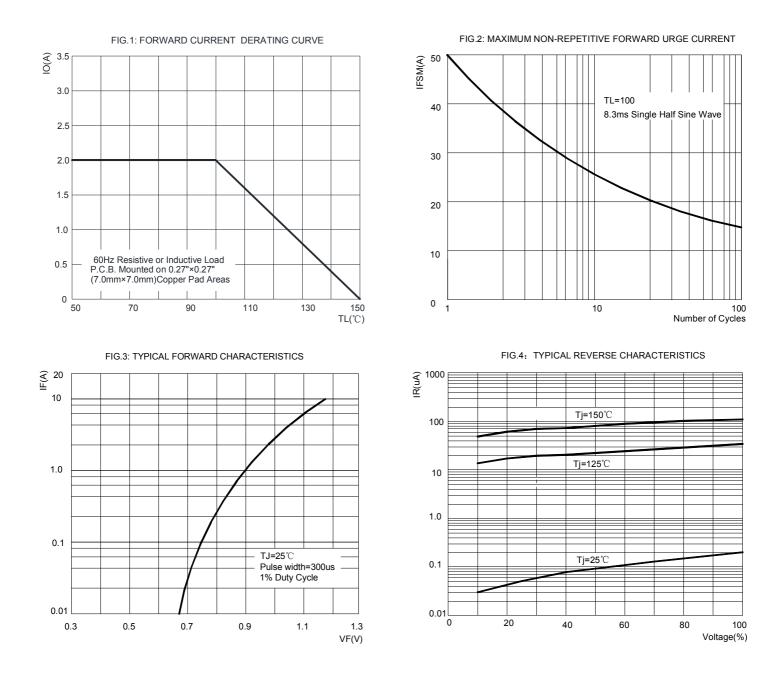
			Test Condition		S2							
Item	Symbol	Unit			Α	В	D	G	J	κ	М	
Peak Forward Voltage	V <sub>F</sub>	V	I <sub>F</sub> =2.0A		1.1							
Deels Deveree Current	I <sub>RRM1</sub>	•	A V <sub>RM</sub> =V <sub>RRM</sub>	T <sub>a</sub> =25℃				5.0				
Peak Reverse Current	I <sub>RRM2</sub>	μA		Ta=125℃				125				
Thermal	$R_{\theta_{J}-A}$	°C/W	Between junction and ambient			53						
Resistance(Typical)	R <sub>θJ-L</sub>	0, 11	Between junction and terminal			16						

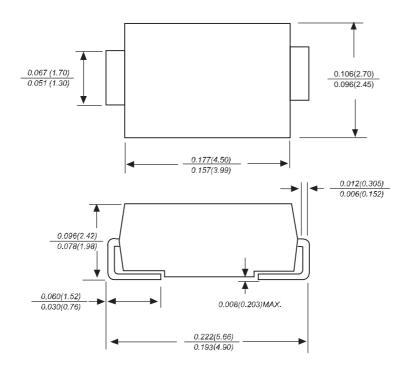
#### Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.27" x 0.27" (7.0 mm x 7.0 mm) copper pad areas



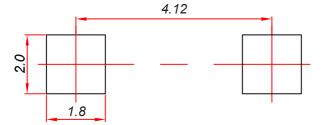
## **Typical Characteristics**





Dimensions in inches and (millimeters)

## SMAG Suggested Pad Layout



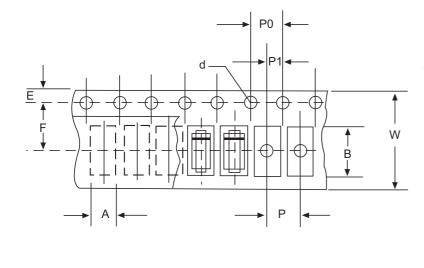
#### Note:

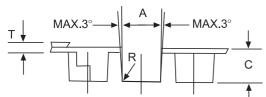
Controlling dimension:in millimeters.
General tolerance:±0.05mm.
The pad layout is for reference purposes only.

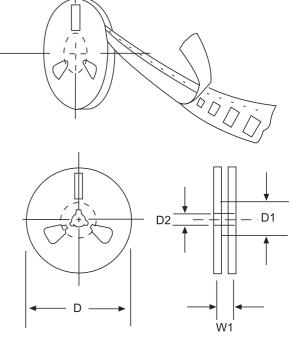
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## **Reel Taping Specifications For Surface Mount Devices- SMAG**







## FIG: CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SMAG mm(inch)
Carrier width	A	2.79±0.1(0.110±0.004)
Carrier length	В	5.33±0.1(0.210±0.004)
Carrier depth	С	2.36±0.1(0.093±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	279±2.0 (11±0.079)
Reel inner diameter	D1	75±1.0 (2.95±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Strocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	5.5±0.05(0.217±0.002)
Punch hole pitch	Р	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Totall tape thickness	Т	0.28±0.02(0.011±0.0008)
Tape width	W	12.0±0.2(0.472±0.008)
Reel width	W1	16.8±2.0(0.661±0.079)

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.

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